

SN54LV367A, SN74LV367A HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS398A – APRIL 1998 – REVISED JULY 1998

- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Typical V_{OLP} (Output Ground Bounce) $< 0.8\text{ V}$ at V_{CC} , $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{OH} Undershoot) $> 2\text{ V}$ at V_{CC} , $T_A = 25^\circ\text{C}$**
- **True Outputs**
- **Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)**

description

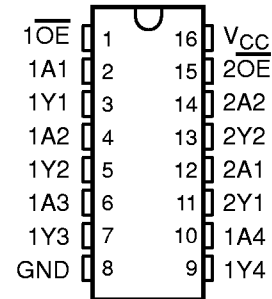
The 'LV367A devices are hex buffers and line drivers designed for 2-V to 5.5-V V_{CC} operation. These devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The 'LV367A devices are organized as dual 4-line and 2-line buffers/drivers with active-low output-enable ($\overline{1OE}$ and $\overline{2OE}$) inputs. When \overline{OE} is low, the device passes noninverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

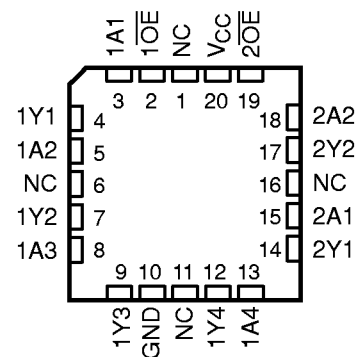
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54LV367A is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LV367A is characterized for operation from -40°C to 85°C .

SN54LV367A . . . J OR W PACKAGE
SN74LV367A . . . D, DB, DGV, NS, OR PW PACKAGE
(TOP VIEW)



SN54LV367A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE
(each buffer/driver)

INPUTS		OUTPUT
\overline{OE}	A	Y
H	X	Z
L	H	H
L	L	L



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

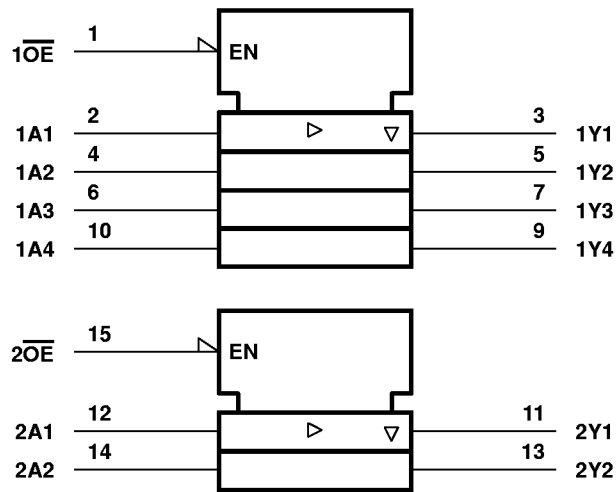
Copyright © 1998, Texas Instruments Incorporated

PRODUCT PREVIEW

SN54LV367A, SN74LV367A HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

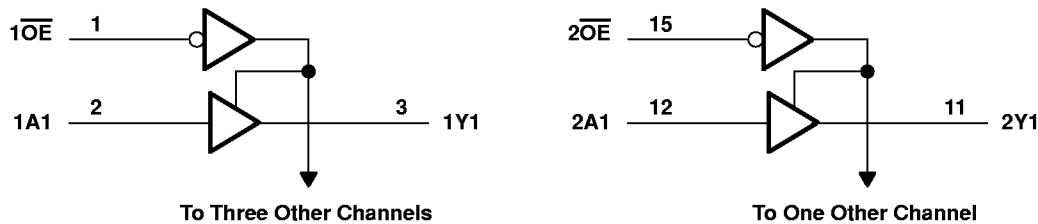
SCLS398A – APRIL 1998 – REVISED JULY 1998

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

PRODUCT PREVIEW

SN54LV367A, SN74LV367A
HEX BUFFERS AND LINE DRIVERS
WITH 3-STATE OUTPUTS

SCLS398A – APRIL 1998 – REVISED JULY 1998

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Output voltage range applied in the high or low state, V_O (see Notes 1 and 2)	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range applied in high-impedance or power-off state, V_O (see Note 1)	-0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$)	-20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 35 mA
Continuous current through V_{CC} or GND	± 70 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	113°C/W
DB package	131°C/W
DGV package	180°C/W
NS package	111°C/W
PW package	149°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 7 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51.

PRODUCT PREVIEW



SN54LV367A, SN74LV367A HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS398A – APRIL 1998 – REVISED JULY 1998

recommended operating conditions (see Note 4)

		SN54LV367A		SN74LV367A		UNIT	
		MIN	MAX	MIN	MAX		
V_{CC}	Supply voltage	2	5.5	2	5.5	V	
V_{IH}	High-level input voltage	$V_{CC} = 2\text{ V}$	1.5	1.5		V	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
V_{IL}	Low-level input voltage	$V_{CC} = 2\text{ V}$	0.5	0.5		V	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$			
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$			
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$V_{CC} \times 0.3$	$V_{CC} \times 0.3$			
V_I	Input voltage	0	5.5	0	5.5	V	
V_O	Output voltage	High or low state	0	V_{CC}	0	V_{CC}	V
		3-state	0	5.5	0	5.5	
I_{OH}	High-level output current	$V_{CC} = 2\text{ V}$		-50	-50	μA	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$		-2	-2	mA	
		$V_{CC} = 3\text{ V to }3.6\text{ V}$		-8	-8		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$		-16	-16		
I_{OL}	Low-level output current	$V_{CC} = 2\text{ V}$		50	50	μA	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$		2	2	mA	
		$V_{CC} = 3\text{ V to }3.6\text{ V}$		8	8		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$		16	16		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	0	200	0	200	ns/V
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	0	100	0	100	
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	0	20	0	20	
T_A	Operating free-air temperature	-55	125	-40	85	$^{\circ}\text{C}$	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

PRODUCT PREVIEW



SN54LV367A, SN74LV367A HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS398A – APRIL 1998 – REVISED JULY 1998

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	SN54LV367A			SN74LV367A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V _{OH}	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1			V _{CC} -0.1			V
	I _{OH} = -2 mA	2.3 V	2			2			
	I _{OH} = -8 mA	3 V	2.48			2.48			
	I _{OH} = -16 mA	4.5 V	3.8			3.8			
V _{OL}	I _{OL} = 50 μA	2 V to 5.5 V				0.1			V
	I _{OL} = 2 mA	2.3 V				0.4			
	I _{OL} = 8 mA	3 V				0.44			
	I _{OL} = 16 mA	4.5 V				0.55			
I _I	V _I = V _{CC} or GND	5.5 V	±1			±1			μA
I _{OZ}	V _O = V _{CC} or GND	5.5 V	±5			±5			μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V	20			20			μA
I _{off}	V _I or V _O = 0 to 5.5 V	0 V	5			5			μA
C _i	V _I = V _{CC} or GND	3.3 V							pF
		5 V							

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54LV367A		SN74LV367A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd} *	A	Y	C _L = 15 pF							ns	
t _{en} *	\overline{OE}	Y									
t _{dis} *	\overline{OE}	Y									
t _{pd}	A	Y	C _L = 50 pF							ns	
t _{en}	\overline{OE}	Y									
t _{dis}	\overline{OE}	Y									

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54LV367A		SN74LV367A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd} *	A	Y	C _L = 15 pF							ns	
t _{en} *	\overline{OE}	Y									
t _{dis} *	\overline{OE}	Y									
t _{pd}	A	Y	C _L = 50 pF							ns	
t _{en}	\overline{OE}	Y									
t _{dis}	\overline{OE}	Y									

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

PRODUCT PREVIEW



SN54LV367A, SN74LV367A HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS398A – APRIL 1998 – REVISED JULY 1998

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54LV367A		SN74LV367A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd} *	A	Y	C _L = 15 pF								ns
t _{en} *	\overline{OE}	Y									
t _{dis} *	\overline{OE}	Y									
t _{pd}	A	Y	C _L = 50 pF								ns
t _{en}	\overline{OE}	Y									
t _{dis}	\overline{OE}	Y									

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 5)

PARAMETER	SN74LV367A			UNIT
	MIN	TYP	MAX	
V _{OL(P)} Quiet output, maximum dynamic V _{OL}				V
V _{OL(V)} Quiet output, minimum dynamic V _{OL}				V
V _{OH(V)} Quiet output, minimum dynamic V _{OH}				V
V _{IH(D)} High-level dynamic input voltage				V
V _{IL(D)} Low-level dynamic input voltage				V

NOTE 5: Characteristics are for surface-mount packages only.

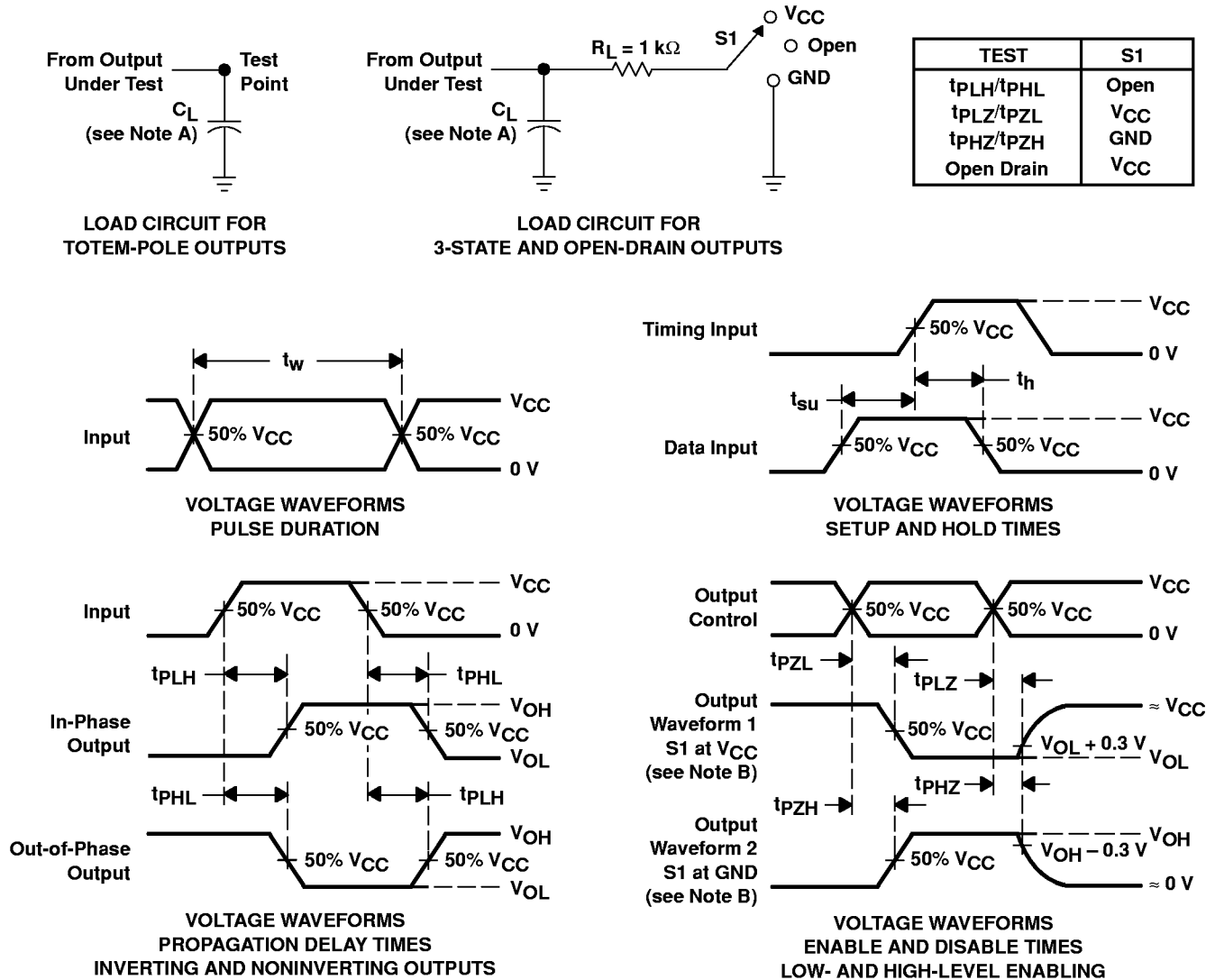
operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	V _{CC}	TYP	UNIT
C _{pd} Power dissipation capacitance	Outputs enabled	C _L = 50 pF, f = 10 MHz	3.3 V		pF
	Outputs disabled				
	Outputs enabled		5 V		
	Outputs disabled				

PRODUCT PREVIEW



PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PHL} and t_{PLH} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

PRODUCT PREVIEW

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.